

Low-melting point tin Bi57Sn42Ag1 - 1,25mm / 25g solder

Product ID: 23381

Price: **13.00 EUR**

Product weight: **0.25 kg**

Description:

Low-melting point tin Bi57Sn42Ag1 - 1,25mm / 25g solder (57% bismuth, 42% tin, 1% silver) is manufactured from primary raw materials in their first melt. It has a low melting temperature, making it suitable for soldering devices and components that are sensitive to damage from higher temperatures when using conventional solders. It features excellent wettability and fast flow. The alloy complies with the ROHS directive (2002/95/EC).

Contact details:
Telefon: +48 17 227 00 25
Infolinia:0 801 671 717
E-mail: biuro@multi-com.pl

Adsress:
Multi-COM Sp. z o.o.
ul. Stanisława Krzaklewskiego 31b
36-100 Kolbuszowa
POLSKA

Go to the product